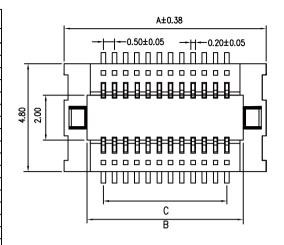
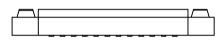
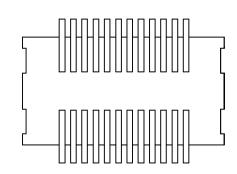
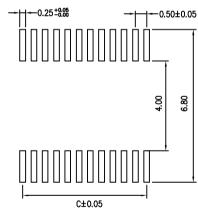
l	ט ן	Dimension			
Circuits	Α	В	С		
10	5.50	3.45	2.00		
12	6.00	3.95	2.50		
14	6.50	4.45	3.00		
16	7.00	4.95	3.50		
18	7.50	5.45	4.00		
20	8.00	5.95	4.50		
22	8.50	6.45	5.00		
24	9.00	6.95	5.50		
26	9.50	7.45	6.00		
28	10.00	7.95	6.50		
30	10.50	8.95	7.00		
32	11.00	8.95	7.50		
34	11.50	9.45	8.00		
36	12.00	9.95	8.50		
38	12.50	10.45	9.00		
40	13.00	10.95	9.50		
42	13.50	11.45	10.00		
44	14.00	11.95	10.50		
46	14.50	12.45	11.00		
48	15.00	12.95	11.50		
50	15.50	13.45	12.00		
52	16.00	13.95	12.50		
54	16.50	14.45	13.00 13.50		
56	17.00	14.95	13.50		
58	17.50	15.45	14.00		
60	18.00	15.95	14.50		
62	18.50	16.45	15.00		
64	19.00	16.95	15.50		
66	19.50	17.45	16.00		
68	20.00	17.95	16.50		
70	20.50	18.45	17.00		
72	21.00	18.95	17.50		
74	21.50	19.45	18.00		
76	22.00	19.95	18.50		
78	22.50	20.45	19.00		
80	23.00	20.95	19.50		
82	23.50	21.45	20.00		
84	24.00	21.95	20.50		
86	24.50	22.45	21.00		
88	25.00	22.95	21.50		
90	25.50	23.45 23.95	22.00 22.50		
92	26.00	23.95	22.50		
94	26.50	24.45	23.00		
96	27.00	24.95	23.50		
98	27.50	25.45	24.00		
100	28.00	25.95	24.50		











Reconnended P.C.Board

Hole Layout

MATERIALS:

- (1) HOUSING: HI-TEMP.PLASTIC(94V-0)
- (2) CONTACT:

 COPPER ALLOY(t=0.2mm)

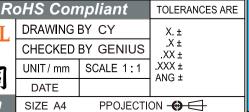
 PLATING GOLD OVER NICKEL
 SPECIFICATION:
 - (1) CURRENT RATING: 0.5A MAX
 - (2) INSULATION RESISTANCE: 1000 M MIN AT 500V DC.
 - (3) DIELECTRIC WITHSTANDING VOLTAGE: 150V(r.m.s) AC AT 0.5mA FOR 1 MINUTE
 - (4) CONTACT RESISTANCE: 50m MAX.
 - (5) OPERATING TEMPERATURE: -40℃~+105℃
 - (6) MAX. PROCESSING TEMP: 230°C FOR 30 ~ 60 SECONDS

Mated Heigh		PART NO.	Н	
3.0mm	MALE	NP0519-P05X-xxx	1.25	
	FEMALE	NP0519-S25X-xxx	2.85	l



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DESCRIPTION: 0.5mm Board to Board Stacked Height 3.0mm Socket Type